

# ST2310DHI

## HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

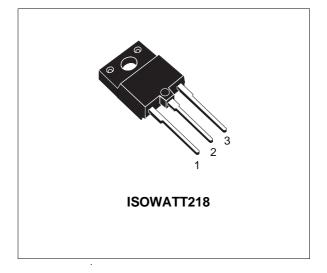
- NEW SERIES, ENHANCED PERFORMANCE
- FULLY INSULATED PACKAGE (U.L. COMPLIANT) FOR EASY MOUNTING
- INTEGRATED FREE WHEELING DIODE
- HIGH VOLTAGE CAPABILITY (> 1500 V)
- HIGH SWITCHING SPEED
- TIGTHER hfe CONTROL
- IMPROVED RUGGEDNESS

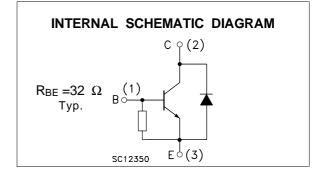
#### **APPLICATIONS:**

HORIZONTAL DEFLECTION HIGH END TVS

#### DESCRIPTION

The device is manufactured using Diffused Collector technology for more stable operation Vs base drive circuit variations resulting in very low worst case dissipation.





#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit V	
V <sub>CES</sub>	Collector-Emitter Voltage (V <sub>BE</sub> = 0)	1500		
Vceo	Collector-Emitter Voltage $(I_B = 0)$	600	V	
VEBO	Emitter-Base Voltage (I <sub>C</sub> = 0)	7	V	
Ι <sub>C</sub>	Collector Current	12	A	
Iсм	Collector Peak Current (t <sub>p</sub> < 5 ms)	25	A	
IB	Base Current	7	A	
Ptot	Total Dissipation at $T_c = 25$ °C	55	W	
V <sub>isol</sub>	Insulation Withstand Voltage (RMS) from All Three Leads to External Heatsink	2500	V	
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C	
Tj	Max. Operating Junction Temperature	150	°C	

December 2002

## THERMAL DATA

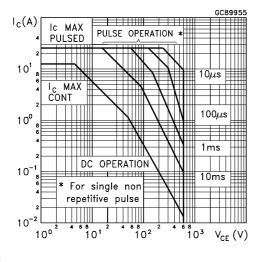
R <sub>thj-case</sub> Thermal Resistance Junction-case	Max	2.3	°C/W
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## **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25 \, {}^{\circ}C$ unless otherwise specified)

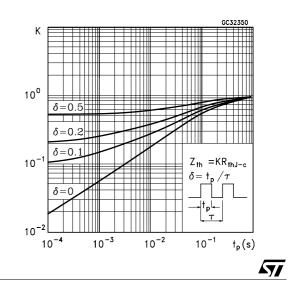
Symbol	Parameter	Test C	onditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector Cut-off Current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 1500 V V <sub>CE</sub> = 1500 V	T <sub>J</sub> = 125 <sup>o</sup> C			1 2	mA mA
I <sub>EBO</sub>	Emitter Cut-off Current $(I_C = 0)$	$V_{EB} = 4 V$		80		250	mA
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage (I <sub>C</sub> = 0)	I <sub>E</sub> = 800 mA		7			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 7 A	I <sub>B</sub> = 1.75 A			3	V
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage	I <sub>C</sub> = 7 A	I <sub>B</sub> = 1.75 A			1.1	V
h <sub>FE</sub> *	DC Current Gain	I <sub>C</sub> = 1 A I <sub>C</sub> = 7 A I <sub>C</sub> = 7 A	V <sub>CE</sub> = 5 V V <sub>CE</sub> = 1 V V <sub>CE</sub> = 5 V	5.5	15 5	8.5	
t <sub>s</sub> t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time	0	$\label{eq:BE} \begin{array}{l} f = 32 \ \text{KHz} \\ V_{\text{BE}(\text{off})} = -2.5 \ \text{V} \\ (\text{see figure 1}) \end{array}$		2 0.25	2.5 0.5	μs μs
Vf	Diode Forward Voltage	I <sub>C</sub> = 7 A			1.5	2.2	V

\* Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5 %

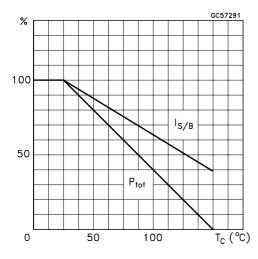
## Safe Operating Area



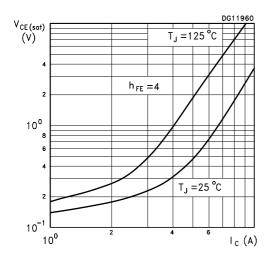
Thermal Impedance



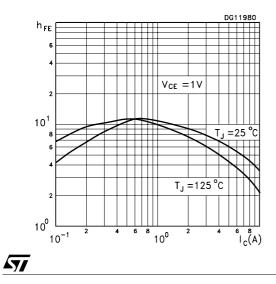
## **Derating Curve**



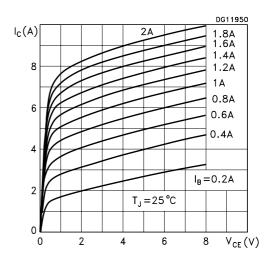
Collector Emitter Saturation Voltage



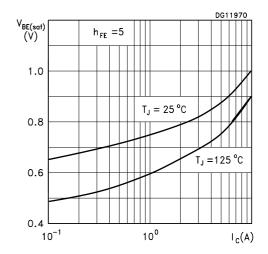
## DC Current Gain



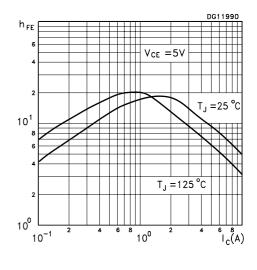
## **Output Characteristics**



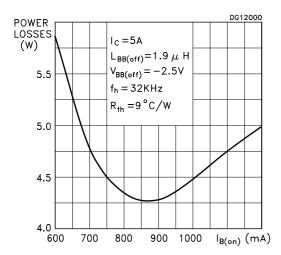
## Base Emitter Saturation Voltage



## DC Current Gain



#### Power Losses



### **Reverse Biased SOA**

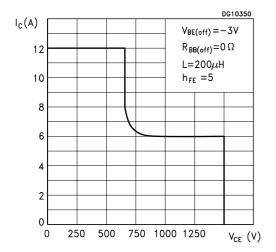
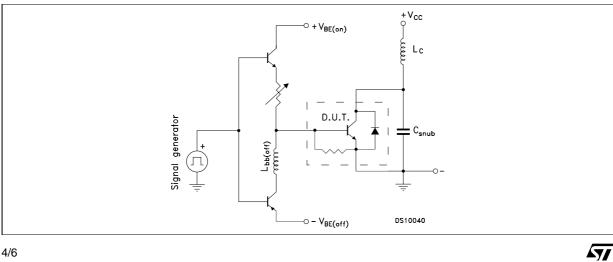
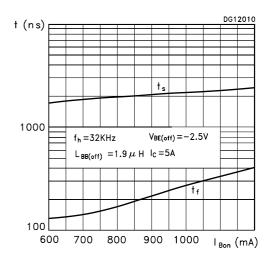


Figure 1: Inductive Load Switching Test Circuit.



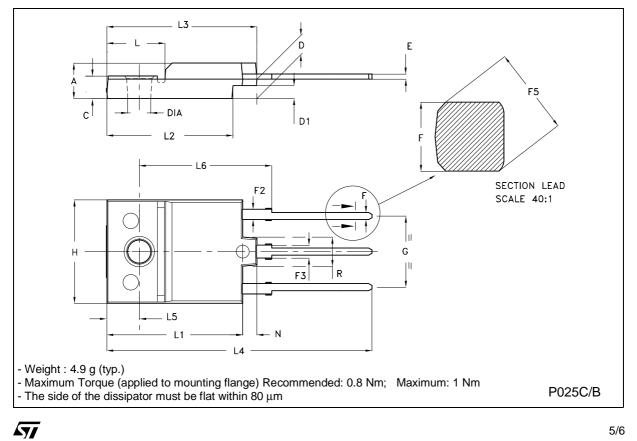
## Switching Time Inductive Load



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DIM	mm		inch			
DIM.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	5.35		5.65	0.211		0.222
С	3.30		3.80	0.130		0.150
D	2.90		3.10	0.114		0.122
D1	1.88		2.08	0.074		0.082
E	0.75		0.95	0.030		0.037
F	0.75		0.95	0.030		0.037
F2	1.50		1.70	0.059		0.067
F3	1.90		2.10	0.075		0.083
F5			1.10			0.043
G	10.80		11.20	0.425		0.441
Н	15.80		16.20	0.622		0.638
L		9			0.354	
L1	20.80		21.20	0.819		0.835
L2	19.10		19.90	0.752		0.783
L3	22.80		23.60	0.898		0.929
L4	40.50		42.50	1.594		1.673
L5	4.85		5.25	0.191		0.207
L6	20.25		20.75	0.797		0.817
Ν	2.1		2.3	0.083		0.091
R		4.6			0.181	
DIA	3.5		3.7	0.138		0.146

## **ISOWATT218 NARROW LEADS MECHANICAL DATA**



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